

Product/Process Change Notice - PCN 10_0221 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of publication date. ADI contact information is listed below.

PCN Title: Halogen Free Material Change for ADG736 - mini SOIC Product.

Publication Date: 17-Aug-2010

Effectivity Date: 15-Nov-2010 (the earliest date that a customer could expect to receive changed material)

Revision Description:

Initial Release

Description Of Change

This is a change of mold compound material for assembly of ADG736 - mini SOIC product.

From this mold compound: Sumitomo 6600H To this mold compound: Sumitomo G600

G600 mold compound is low halogen/halogen free with <900 ppm Br-, <900 ppm Cl-, and <1500 ppm combined Br- and Cl- content.

Reason For Change

ADI is standardizing on halogen free package materials that have equivalent or improved material properties in response to our customer and industry demands for halogen free "green" products.

Impact of the change (positive or negative) on fit, form, function & reliability

This change does not affect fit, form, function or reliability of the products

Product Identification (this section will describe how to identify the changed material)

The earliest date code of the changed product is Date Code 1024

Summary of Supporting Information

Qualification has been performed per ADI0012, Procedure for Qualification of New or Revised Processes. See attached Reliability Report.

Supporting Documents

Attachment 1: Type: Reliability Report

ADI_PCN_10_0221_Rev_- ADG736_Mini SOIC Qualification Data.pdf

For questions on this PC	N. send email to the regiona	I contacts below or contact	your local ADI sales representative
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 Americas:
 PCN_Americas@analog.com
 Europe:
 PCN_Europe@analog.com
 Japan:
 PCN_Japan@analog.com

 Rest of Asia:
 PCN ROA@analog.com

Appendix A - Affected ADI Models						
Added Parts On This Revision - Product Family / Model Number (9)						
ADG736 / ADG736BRM	ADG736 / ADG736BRM-REEL	ADG736 / ADG736BRM-REEL7	ADG736 / ADG736BRMZ	ADG736 / ADG736BRMZ-REEL	ADG736 / ADG736BRMZ-REEL7	
ADG736L / ADG736LBRMZ	ADG736L / ADG736LBRMZ-REEL	ADG736L / ADG736LBRMZ-REEL7				

Appendix B - Revision History				
Rev	Publish Date	Rev Description		
Rev	17-Aug-2010	Initial Release		

Analog Devices, Inc.

Docld:1242 Parent Docld:969 Layout Rev.3